

## INCHANGE SEMICONDUCTOR

## isc N-Channel Mosfet Transistor

## BUZ74

### FEATURES

- Drain Source Voltage-
  - : V<sub>DSS</sub>= 500V(Min)
- Static Drain-Source On-Resistance
  - :  $R_{DS(on)}$  = 3.0  $\Omega$  (Max)
- Fast Switching Speed
- Low Drive Requirement
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

### DESCRITION

Designed for witched mode power supplies,motor control, welding,DC-DC & DC-AC converters, and in general purpose switching applications.switching regulators, switching converters.

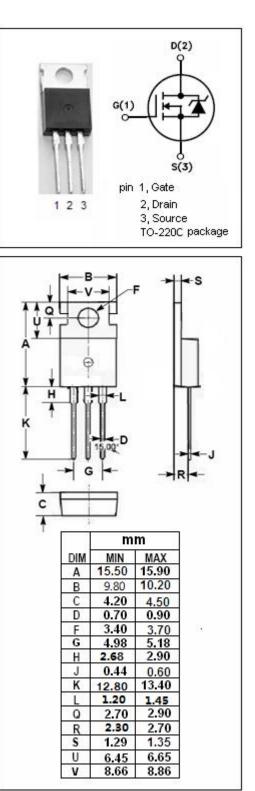
SYMBOL	ARAMETER	VALUE	UNIT
V <sub>DSS</sub>	Drain-Source Voltage (V <sub>GS</sub> =0)	500	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
ID	Drain Current-continuous@ TC=30°C	2.4	A
I <sub>DM</sub>	Drain Current-Single Plused	9.5	А
P <sub>tot</sub>	Total Dissipation@TC=25°C	40	W
Tj	Max. Operating Junction Temperature	150	°C
T <sub>stg</sub>	Storage Temperature Range	-55~150	°C

## • ABSOLUTE MAXIMUM RATINGS(Ta=25°C)

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	МАХ	UNIT
R <sub>th j-c</sub>	Thermal Resistance, Junction to Case	3.1	°C/W
R <sub>th j-a</sub>	Thermal Resistance, Junction to Ambient	75	°C/W

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## **ELECTRICAL CHARACTERISTICS**

#### $T_{\text{C}}\text{=}25^{\circ}\!\!\!\!\mathrm{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	TYPE	МАХ	UNIT
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0; I <sub>D</sub> =0.25mA	500			V
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> ; I <sub>D</sub> =1mA	2.1		4.0	V
V <sub>SD</sub>	Diode Forward On-voltage	I <sub>S</sub> = 4.8A ;V <sub>GS</sub> = 0			1.3	V
R <sub>DS(on)</sub>	Drain-Source On-Resistance	V <sub>GS</sub> = 10V; I <sub>D</sub> = 1.5A			3.0	Ω
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> = ±20V;V <sub>DS</sub> = 0			±100	nA
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> =500V; V <sub>GS</sub> = 0			1	μA
Gfs	Forward Transconductance	V <sub>DS</sub> = 25V; I <sub>D</sub> =1.5A	1.8			S
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>GS</sub> =10V;			12	
tr	Rise Time	I <sub>D</sub> =2.1A;			60	
t <sub>d(off)</sub>	Turn-off Delay Time	ປ <sub>DD</sub> =30V; R <sub>GS</sub> =50 Ω			65	ns
t <sub>f</sub>	Fall Time				40	

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